Digital Attenuator Die, 6-Bit, Parallel Control 0.1 - 30 GHz, 31.5 dB Attenuation Range



MAAD-011036-DIE

Rev. V3

Features

- 6-Bit Digital Attenuator, 0.5 dB LSB
- 31.5 dB Attenuation Range
- Wide Frequency Range: 0.1 30 GHz
- Parallel Control:
 - Complementary Controls (per bit)
- Attenuation Accuracy: typ. +/-(0.5 + 5% of Attenuation Setting) dB
- Die Size: 2.73 x 1.38 x 0.10 mm

Applications

- Test Equipment (instrumentation)
- Communications (commercial and military) : Cellular Infrastructure Radars Radios (MMW)
- General Purpose

Description

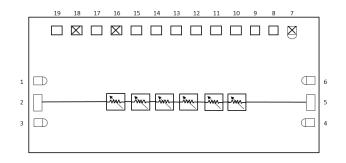
The MAAD-011036-DIE is a 6-bit, 0.5 dB step GaAs pHEMT MMIC digital attenuator covering a large frequency range from 0.1 to 30 GHz with excellent insertion loss and attenuation accuracy.

This device is ideally suited for use where high accuracy, very low power consumption, and low intermodulation products are required.

Ordering Information

Part Number	Package			
MAAD-011036-DIE	Die in Gel Pack			

Functional Schematic



Pin Configuration

Pin #	Function	Description		
1, 3, 4, 6	GND	Ground ¹		
2	RF IN	Input RF		
5	RF OUT	Output RF		
7, 16, 18	NC	No Connection		
8	Vcontrol_B6	16 dB BIT Vcontrol_B6		
9	Vcontrol_A6	16 dB BITVcontrol_A6		
10	Vcontrol_B5	8 dB BIT Vcontrol_B5		
11	Vcontrol_A5	8 dB BIT Vcontrol_A5		
12	Vcontrol_B4	4 dB BIT Vcontrol_B4		
13	Vcontrol_A4	4 dB BIT Vcontrol_A4		
14	Vcontrol_B3	2 dB BIT Vcontrol_B3		
15	Vcontrol_A3	2 dB BIT Vcontrol_A3		
17	Vcontrol_A2	BIT 1 dB Control_A2		
19	Vcontrol_A1	BIT 0.5 dB Control_A1		

1. All GND bondpads are connected to the secondary side of the die with substrate vias.

* Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

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Electrical Specifications^{2,3,4} Freq. = 0.1 - 30 GHz, $T_A = 25^{\circ}$ C, $Z_0 = 50 \Omega$, $V_C = -5 V / 0 V$, $P_{IN} = 0 dBm$

Parameter	Test Conditions	Units	Min.	Тур.	Max.	
Reference Insertion Loss	0.1 - 18.0 GHz 18.0 - 26.5 GHz 26.5 - 30.0 GHz	dB		3.2 4.2 5.2	4.2 — 6.0	
RMS Attenuation Error	0.1 - 30.0 GHz	dB	—	0.6		
Attenuation Accuracy	Relative to Insertion Loss	± (0.5 ·	± (0.5 + 5% of attenuation setting) dB typ.			
Return Loss	All states (worst case)		_	-12		
Input P0.1dB	Reference State	dBm		21		
IIP32-Tone, +10 dBm/tone, 1 MHz Spacing (Reference State)		dBm	_	43	_	
T _{RISE} , T _{FALL}	10% to 90% RF, 90% to 10% RF		—	15		
V _C Current	current Per bit		—	0.5		

2. Two bond-wires are recommended on pin 2 and 5 (1 mil diameter each). Keep these bonds to a minimum length (<130 μm).

3. Pins 1, 3, 17 and 19 must be RF/DC grounded thru bond wires (1 mil), one bond wire per GND pin.

4. RMS Calculation Discussion:

RMS Error is used directly to calculate system parameters. To derive RMS error, first normalize the attenuation for all conditions to the minimum loss condition. Next calculate an absolute error by taking the difference between the normalized measurement and the ideal attenuator loss for each state. By using this with the equation below, the RMS Error can be determined.

RMS ERROR, mean =

$$\sqrt{\frac{1}{n}\sum (Er_i - Er_{Ave})^2}$$

 $Er_i = Ideal Error, Er_{Ave} = Normalized Error, n = number of attenuator bits (attenuator states = 2^(n-1))$

Truth Table⁵

0.5 dB BIT		1 dB BIT		2 dB BIT		4 dB BIT		8 dE	8 dB BIT 16		B BIT	Attenuation	
pin 19	pin 18	pin 17	pin 16	pin 15	pin 14	pin 13	pin 12	pin 11	pin 10	pin 9	Pin 8	(dB)	
0	Х	0	Х	0	1	0	1	0	1	0	1	Reference IL	
1	Х	0	Х	0	1	0	1	0	1	0	1	0.5	
0	Х	1	Х	0	1	0	1	0	1	0	1	1	
0	Х	0	Х	1	0	0	1	0	1	0	1	2	
0	Х	0	Х	0	0	1	0	0	1	0	1	4	
0	Х	0	Х	0	1	0	1	1	0	0	1	8	
0	Х	0	Х	0	1	0	1	0	1	1	0	16	
1	Х	1	Х	1	0	1	0	1	0	1	0	31.5	

5. "0" = -5.3 V to -4.3 V, "1" = -0.2 V to 0 V, "X" = Don't Care.

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Absolute Maximum Ratings^{6,7}

Parameter	Absolute Maximum				
Input Power	31 dBm				
Control Voltage	-5.5 V <u><</u> V _{Controls} <u><</u> 0.5 V				
Junction Temperature	+150°C				
Operating Temperature	-40°C to +85°C				
Storage Temperature	-65°C to +150°C				

6. Exceeding any one or combination of these limits may cause permanent damage to this device.

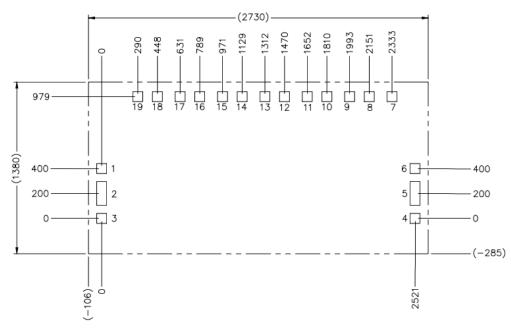
 MACOM does not recommend sustained operation near these survivability limits.

Outline Drawing

Mounting and Bonding Information

The DIE should be directly attached to the RF/DC ground plane; either with solder (AuSn) or a thin application of conductive epoxy. Avoid overflows.

Any connecting microstrip (50 Ω Transmission Line) substrate should be brought as close as possible to the die in order to minimize bond wire inductance. A typical spacing between die and microstrip substrate should be kept between 75 - 125 μ m for best RF behavior. All bonds should be kept as short as possible. Use minimum ultrasonic energy for reliable wire bonds.



Bond Pad Dimensions (µm)

Pad	X	Y
1, 3, 4, 6 - 19	80	80
2, 5	80	192

Unless otherwise specified, all dimensions shown are µm with a tolerance of ±5 µm.

Die thickness is 100 µm ±10 µm.

Bond pad/backside metallization is gold.

Die size reflects un-cut dimensions. Saw, or laser kerf reduces die size by ~25 μ m each dimension.

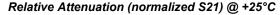
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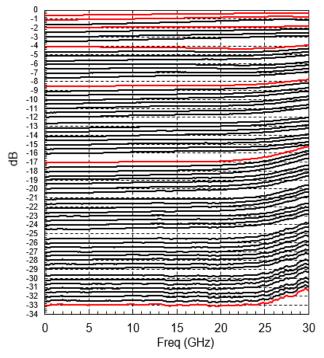
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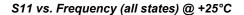
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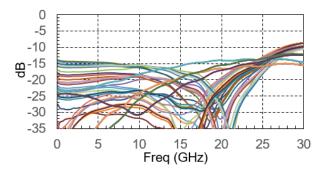


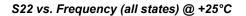
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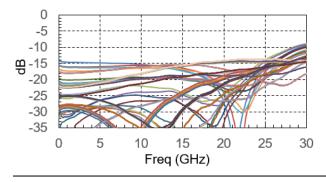






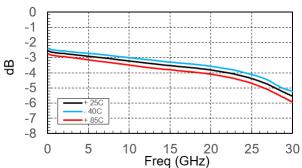




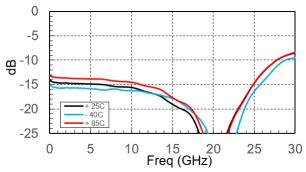




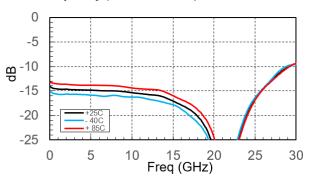
S21 vs. Temperature (reference state)



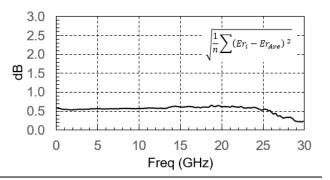
S11 vs. Frequency (reference state)



S22 vs. Frequency (reference state)



RMS Error vs. Frequency (mean) @ +25°C

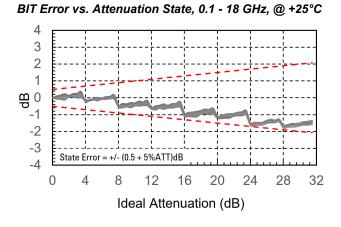


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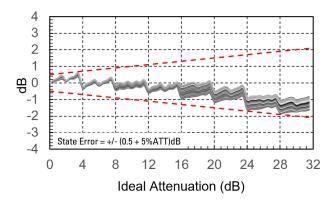
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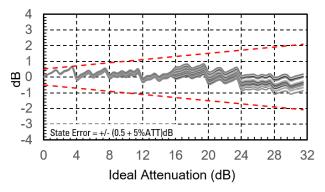
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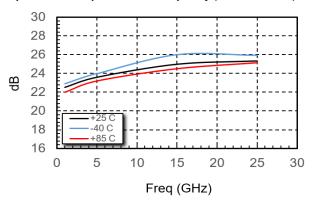
BIT Error vs. Attenuation State, 18 - 26.5 GHz, @ +25°C



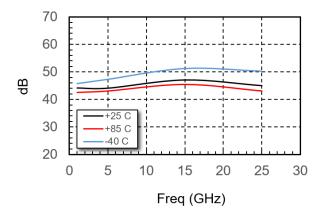
BIT Error vs. Attenuation State, 26.5 - 30 GHz, @ +25°C



Input 0.1dB Compression vs. Frequency (reference state)



Input IP3 vs. Frequency (reference state)



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